



Click [here](#) for the 3D model.

### Dimensions

Chip Size	2220
L	5.69mm +/-0.41mm (0.224 in +/-0.016 in)
W	5mm +/-0.41mm (0.197 in +/-0.016 in)
T	2.79mm MAX (0.11 in MAX)
B	0.64mm +/-0.46mm (0.025 in +/-0.018 in)

### Packaging Specifications

Packaging	Waffle
Packaging Quantity	80

### General Information

Series	SMD MIL X7R PRF32535
Style	SMD Chip
Description	SMD, Military, Low ESR, MIL-PRF-32535
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
Termination	Solder Plated
Failure Rate	N/A
Qualifications	MIL-PRF-32535
AEC-Q200	No
Component Weight	430 mg

### Specifications

Capacitance	4.7 uF
Capacitance Tolerance	10%
Voltage DC	10 VDC
Dielectric Withstanding Voltage	25 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Dissipation Factor	5% 1 kHz 25C
Aging Rate	3% Loss/Decade Hour
Insulation Resistance	110 MOhms

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)